# **MA3X740** (MA740)

### Silicon epitaxial planar type

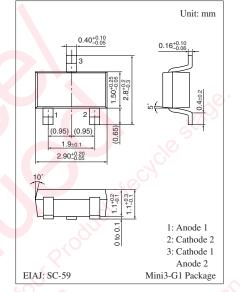
For super high speed switching For small current rectification

#### Features

- Two MA3X721 (MA721) is contained in one package (series connection)
- Forward current (Average)  $I_{F(AV)} = 200 \text{ mA}$  (per single diode) rectification is possible

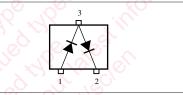
<b>Theorem 1</b> Absolute Maximum Hatings $1_{a} = 25$ C								
Parameter		Symbol	Rating	Unit				
Reverse voltage		V <sub>R</sub>	30	V				
Repetitive peak reverse voltage		V <sub>RRM</sub>	30	V				
Forward current	Single	I <sub>F(AV)</sub>	200	mA				
(Average)	Series		130					
Peak forward	Single	I <sub>FM</sub>	300	mA				
current	Series		220	10				
Non-repetitive peak	Single	I <sub>FSM</sub>	1.0	A				
forward surge current *	Series		0.7	S X				
Junction temperature		Tj	150	°C				
Storage temperature		T <sub>stg</sub>	-55 to +150	°C				

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$



#### Marking Symbol: M3C

#### Internal Connection



Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

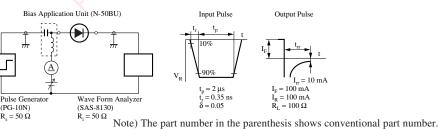
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 200 mA	2		0.55	V
Reverse current	I <sub>R</sub>	$V_R = 30 V$			50	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$		30		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$		3.0		ns
		$I_{rr} = 10 \text{ mA}, R_{L} = 100 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

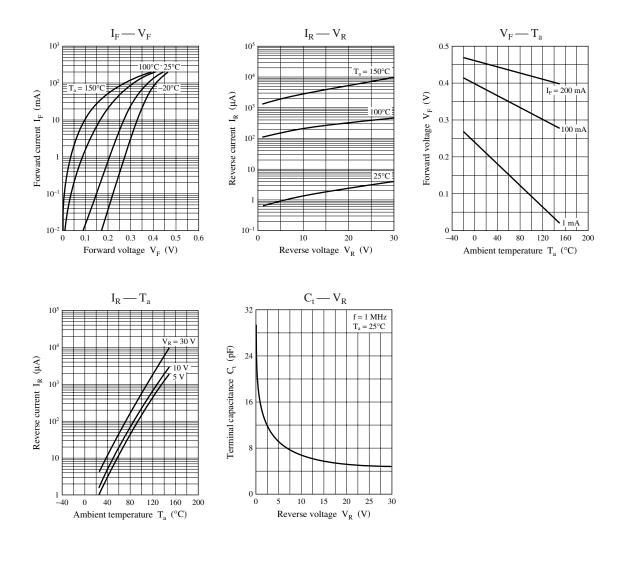
2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

4. \*: trr measurement circuit

3. Absolute frequency of input and output is 1 GHz.



## Panasonic



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